SHEN ZHEN SHI HONGZHOU OPTOELECTRONICS TECH CO.,LTD

Part Number:

G525RC

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1.SPECIFICATIONS

(1) Absolute Maximum Rating

(Ta=25°C)

Item	Symbol Absolute Maximum Rating		Unit	
Forward Current	IF	20	mA	
Peak Forward Cuttent	IFP	50	mA	
Reverse Voltage	VR	3	V	
Power Dissipation	PD	40	mW	
Electrostatic Discharge (HBM)	/	/	V	
Operating Temperature	ТОР	-40°C~80°C	$^{\circ}\!$	
Storage Temperature	TSTG	-40°C~100°C	$^{\circ}\! \mathbb{C}$	
Lead Soldering Temperature	TSOL	260℃ FOR 5 SECONDS		

IFP Conditions: Pulse Width \leq 10msec.and duty \leq 1/10

(2) Initial Electrical/Optical Characteristics

(Ta=25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltahe	VF	IF=20(mA)	3	/	3. 4	V
Reverse Current	IR	VR=5(V)	/	/	20	μΑ
Viewing Angle	2 θ 1/2	IF=20(mA)	/	30	/	deg
Luminous Intensity	IV	IF=20(mA)	5000	/	7000	mcd
Dominant Wavelength	у	IF=20(mA)	520	/	525	
Recommend Forward Current	IF(Rec)	/	/	20	/	mA

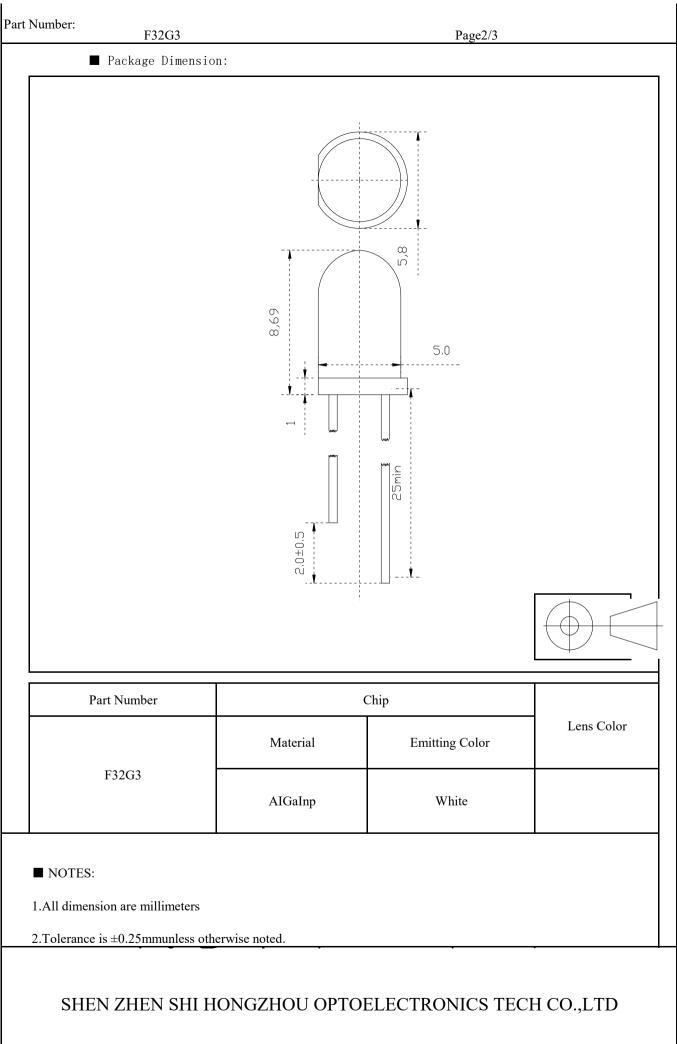
2.TYPICAL INTIAL OPICAL/ELECTRICAL CHARACTERISTICS

3.OUTLINE DIMENSIONS AND MATERIALS

Material as follows: Resin : Epoxy

Lead frame: Ag plating Copper ally

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Part Number: F32G3

■ Typical Electro-Optical Characteristic Curves:

Fig1.Forward Current vs.Forward Voltage

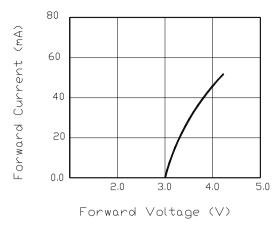


Fig3. Forward Voltage vs. Temperature

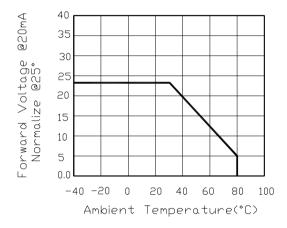


Fig5.Relative Intensity vs. Wavelength

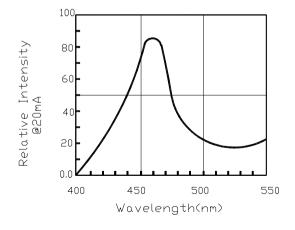
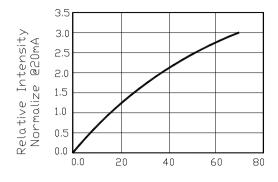
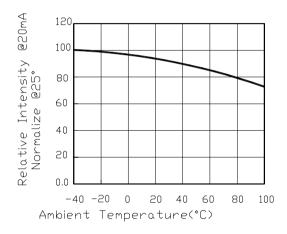


Fig2.Relative Intensity vs. Forward Current

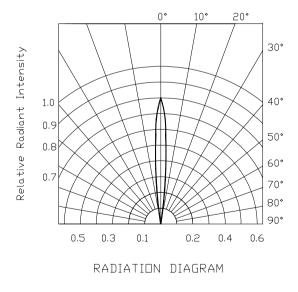


Forward Current(mA)

Fig4.Relative Intensity vs. Temperature



Rodiation Diagram Ta=25°C



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